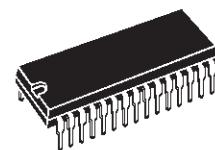


## FIVE BANDS DIGITAL CONTROLLED GRAPHIC EQUALIZER

- VOLUME CONTROL IN 0.375dB STEP
- FIVE BANDS STEREO GRAPHIC EQUALIZER
- CENTER FREQUENCY, BANDWIDTH, MAX BOOST/CUT DEFINED BY EXTERNAL COMPONENTS
- $\pm 14$ dB CUT/BOOST CONTROL IN 2dB/STEP
- ALL FUNCTIONS PROGRAMMABLE VIA SERIAL BUS
- VERY LOW DISTORTION
- VERY LOW NOISE AND DC STEPPING BY USE OF A MIXED BIPOLAR/CMOS TECHNOLOGY



SDIP30

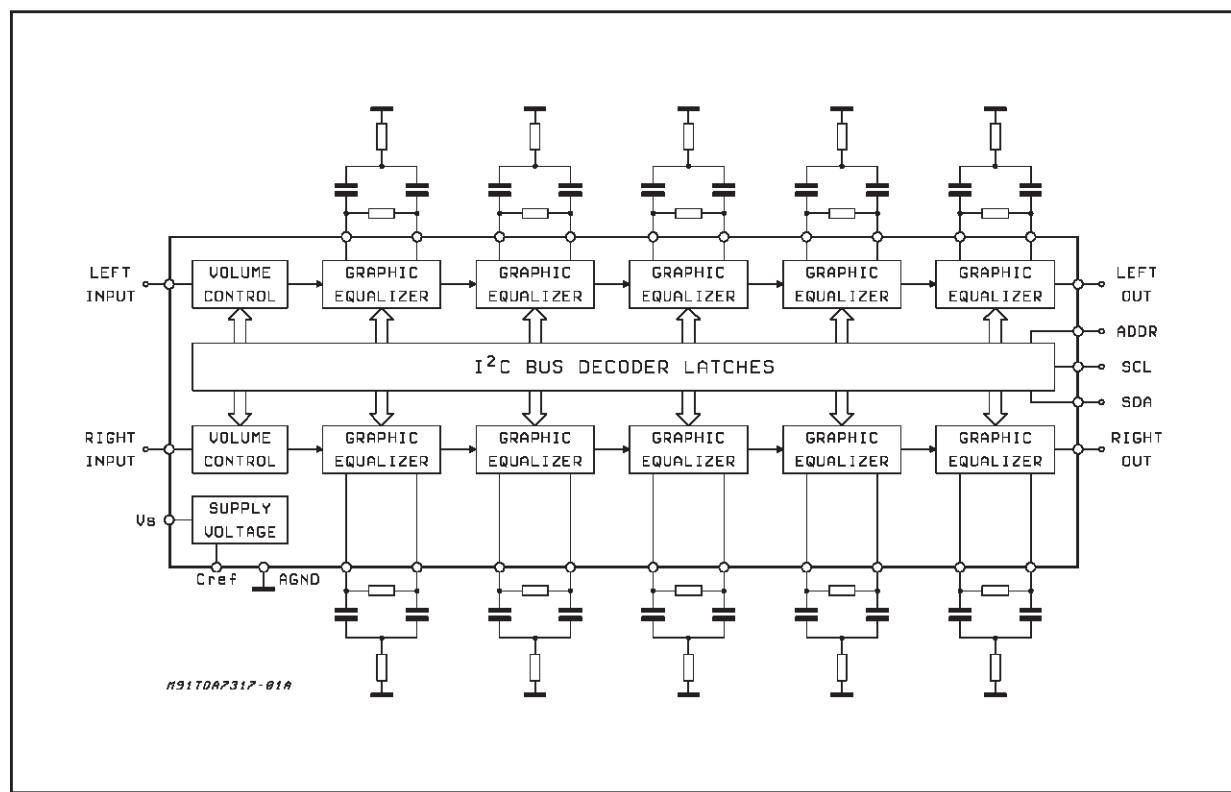
ORDERING NUMBER: TDA7317

### DESCRIPTION

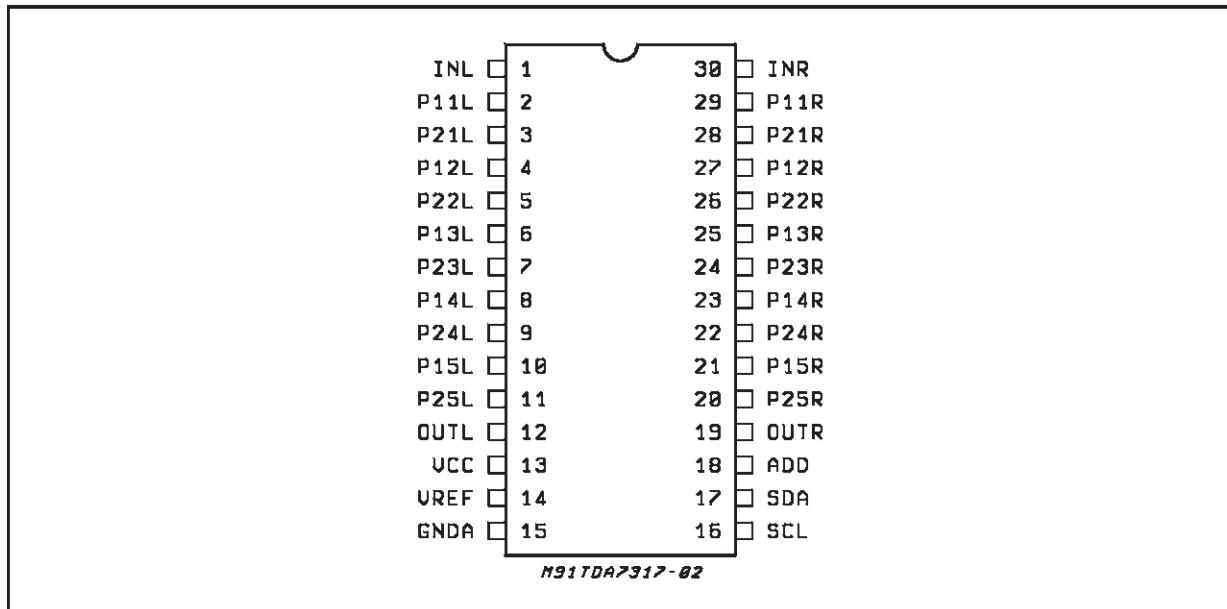
The TDA7317 is a monolithic, digitally controlled graphic equalizer realized in BiCMOS mixed technology. The stereo signal, before any filtering, can be at-

tenuated up to  $-17.625$ dB in 0.375dB step. All the functions can be programmed via serial bus making easy to build a  $\mu$ P controlled system. Signal path is designed for very low noise and distortion.

### BLOCK DIAGRAM



PIN CONNECTION



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_S$	Supply Voltage	10.2	V
$T_{op}$	Operating Temperature Range	-40 to +85	°C
$T_{stg}$	Storage Temperature Range	-55 to +150	°C
$R_{tjvins}$	Thermal Resistance Junction pins	85	°C/W

**ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^\circ\text{C}$ ,  $V_S = 9\text{V}$ ,  $R_L = 10\text{K}\Omega$ ,  $R_g = 600\Omega$ ,  $f = 1\text{KHz}$   $V_{IN} = 1\text{Vrms}$ , all controls in flat position ( $AV = 0\text{dB}$ ) unless otherwise specified).

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
<b>SUPPLY</b>						
$V_S$	Supply Voltage		6	9	10	V
$I_S$	Supply Current		8	14	20	mA
SVR	Ripple Rejection	$f = 300\text{Hz to } 10\text{KHz}$	60	80		dB

## ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
INPUT						
$R_I$	Input Resistance		20	30	40	$\text{K}\Omega$
$V_{IN\ max}$	Max Input Signal	THD = 0.3%	2	2.5		$\text{V}_{\text{RMS}}$
$I_{IN\ S}$	Input Separation (1)		80	100		dB

## VOLUME CONTROL

$C_{\text{RANGE}}$	Control Range		17.625			dB
$A_{V\text{MIN}}$	Min. Attenuation		-0.5	0	0.5	dB
$A_{V\text{MAX}}$	Max. Attenuation		16.7	17.625	18.6	dB
$A_{\text{STEP}}$	Step Resolution		0.175	0.375	0.575	dB
$E_A$	Attenuation Set Error		-1		1	dB
$E_T$	Tracking Error				0.5	dB
$V_{DC}$	DC Steps	adjacent attenuation steps		0	3	mV

## GRAPHIC EQUALIZER

THD	Distortion		0.01	0.1	%	
$C_s$	Channel Separation		80	100		dB
$e_{NO}$	Output Noise	BW = 20Hz to 20KHz flat, AV = 0dB		8	20	$\mu\text{V}$
		A curve		6		$\mu\text{V}$
		BW = 20Hz to 20KHz AV = 0dB All bands = max. boost All bands = max. cut		24		$\mu\text{V}$
$S/N$	Signal to Noise Ratio	AV = 0dB; $V_{\text{ref}} = 1\text{V}_{\text{RMS}}$	100			dB
$B_{\text{step}}$	Step Resolution		1	2	3	dB
$C_{\text{RANGE}}$	Control Range	max boost/cut	$\pm 12$	$\pm 14$	$\pm 16$	dB
$V_{DC}$	DC Steps	Adiacent Control Steps		0.5	3	mV

## AUDIO OUTPUTS

$V_O$	Output Voltage	THD = 0.3%	2	2.5		$\text{V}_{\text{RMS}}$
$R_L$	Output Load Resistance		2			$\text{K}\Omega$
$C_L$	Output Load Capacitance				10	nF
$R_O$	Output Resistance		5	10	20	$\Omega$
$V_{OUT}$	DC Voltage Level		4.2	4.5	4.8	V

## BUS INPUTS

$V_{IL}$	Input Low Voltage				1	V
$V_{IH}$	Input High Voltage		3			V
$I_{IN}$	Input Current		-5		+5	$\mu\text{A}$
$V_O$	Output Voltage SDA Acknowledge	$I_O = 1.6\text{mA}$			0.4	V

ADDRESS PIN (Internal 50K $\Omega$  pull down resistor)

$V_{IL}$	Input Low Voltage				1	V
$V_{IH}$	Input High Voltage		$V_{CC} - 1\text{V}$			V

NOTE: The input is grounded thru the 2.2 $\mu\text{P}$  capacitors

## TDA7317

### DEVICE DESCRIPTION

The TDA7317 is a five bands, digitally controlled stereo Graphic Equalizer.

The device is intended for high quality audio application in Hi-Fi, TV and car radio systems where feature like low noise and THD are key factors. A mixed Bipolar Cmos Technology allows:

Cmos analog switches for pop free commutations, high frequency op.amp. (GWB = 10MHz) and high linearity polysilicon resistor for THD = 0.01 (at Vin = 1Vrms) and a S/N ratio of 102dB.

The internal Block Diagram is shown on page 1.

The first stage is a volume control. The control range is 0 to -17.625dB with 0.375dB step.

The very high resolution (0.375dB step) allows the implementation of closed loop amplitude control system completely free from any acoustical effect (stepping variation and pumping effect).

The volume control is followed by a serial five bands equalizer. Each filtering cell is the biquad cell shown in fig. 1

The internal resistor string is fixing the boost/cut value while the buffer makes the Q (quality factor) and central frequency, set by external components, fully independent from the internal resistors. Each filtering cell is realized using only 4 external components (2 capacitors and 2 resistors) allowing a flexible selection of centre frequency  $f_0$ , Q factor and gain. Here below the basic formulae and the key features of each band pass filter are reported:

$f_0$  = center frequency

$G_v$  = gain/loss at the center frequency  $f_0$

$G_v = 20\log(A_v)$

$$Q = \frac{f_0}{f_2 - f_1}$$

where  $f_2, f_1$  = 3dB Bandwidth limits.

$$A_v = \frac{(R2 \cdot C2) + (R2 \cdot C1) + (R1 \cdot C1)}{(R2 \cdot C1) + (R2 \cdot C2)}$$

$$Q = \frac{\sqrt{(R1 \cdot C1 \cdot R2 \cdot C2)}}{(R2 \cdot C1) + (R2 \cdot C2)}$$

$$f_0 = \frac{1}{2\pi \cdot \sqrt{(R1 \cdot R2 \cdot C1 \cdot C2)}}$$

If  $C1$  is fixed, then:

$$C2 = \frac{Q^2}{A_v - 1 - Q^2} \cdot C1$$

$$R2 = \frac{1}{2\pi \cdot C1 \cdot f_0 \cdot \frac{(A_v - 1) \cdot Q}{(A_v - 1 - Q^2)}}$$

$$R1 = \frac{(A_v - 1)^2}{A_v - 1 - Q^2} \cdot R2$$

Likewise, the components'values can be determined by fixing one of the other three parameters. Referring to fig. 1 the suggested  $R2$  value should be higher than  $2K\Omega$  in order to have a good THD (internal op. amp. current limit).

Viceversa the  $R1$  value should be equal or lower than  $51K\Omega$  in order to keep the "click"(DC step) very low.

A typical application is shown by fig. 2

Fig. 1

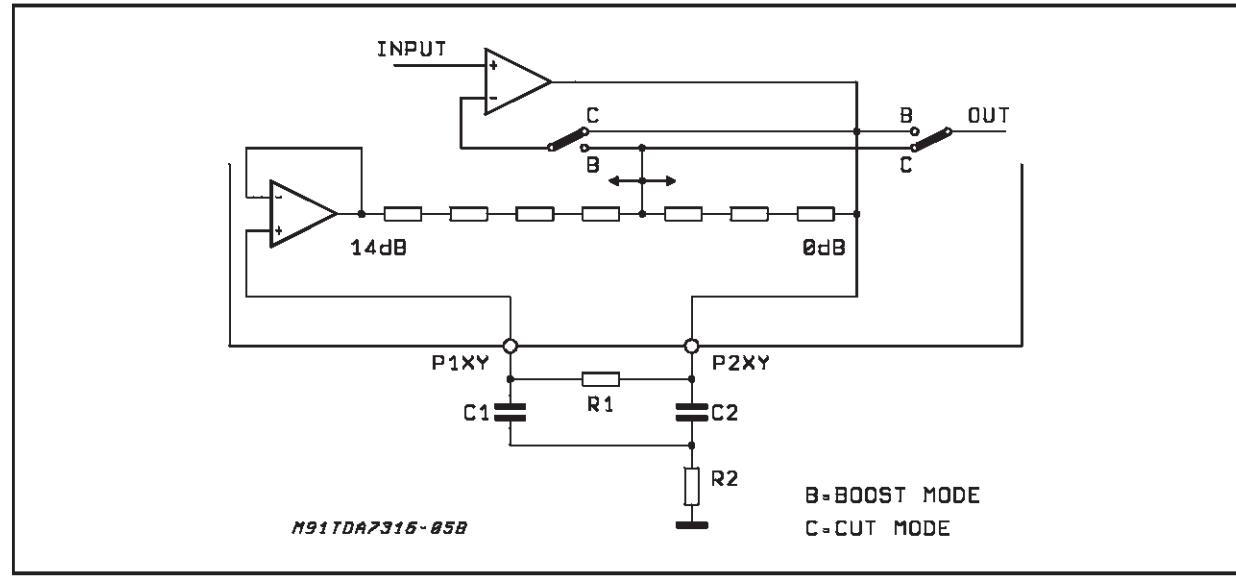
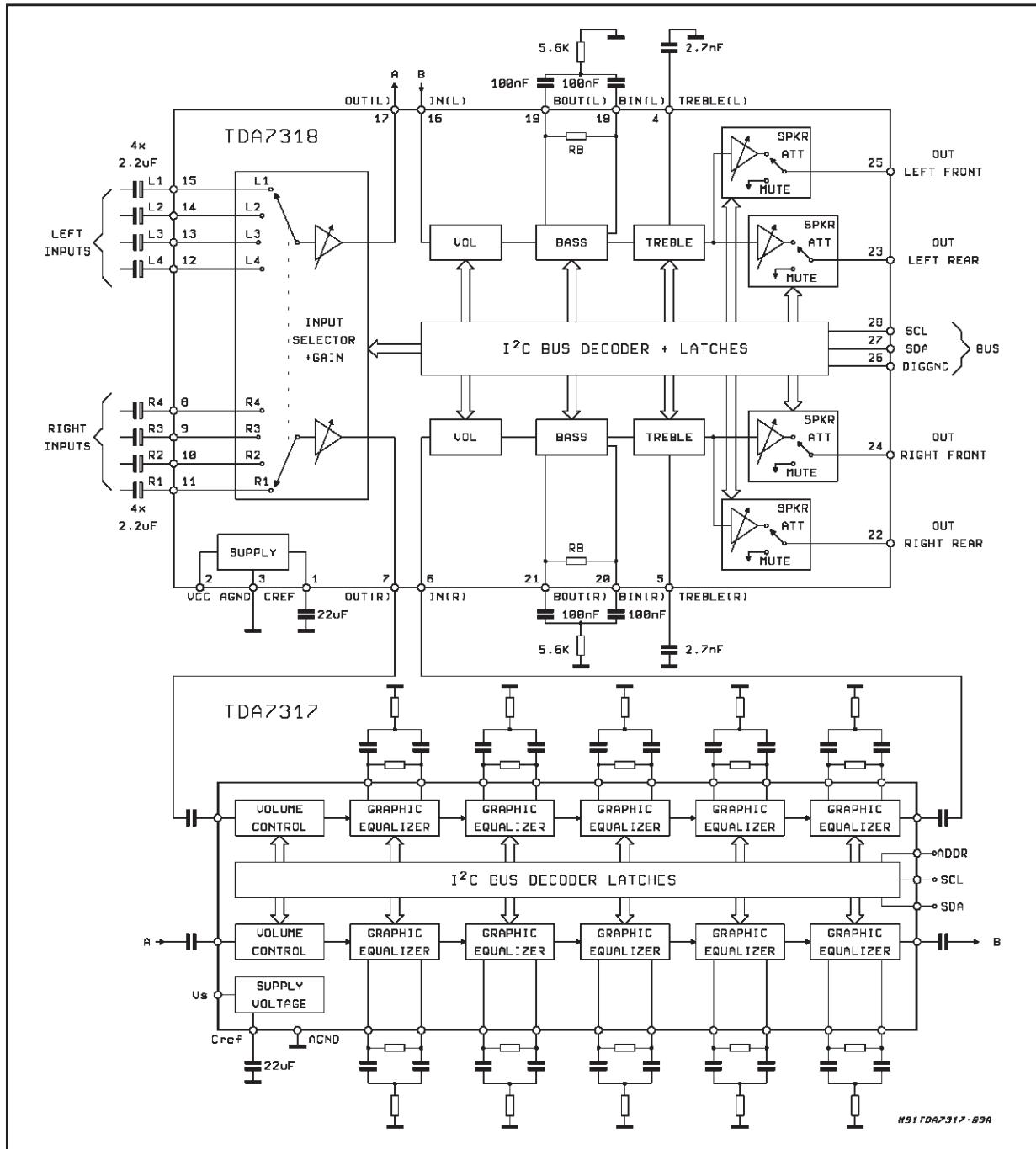


Figure 2: Application Circuit



The five bands graphic equalizer is used in conjunction with a TDA7318 (or another audioprocessor of the SGS-THOMSON 731X family).

The audioprocessor bass and treble tone can furnish two extra filter bands.

Application requiring higher number of external equalizer bands could be implemented by cascading 2 or more TDA7317 devices. In fact the

dedicated ADDR pin allows 2 addresses selection. Anyway, the address of the graphic equalizer is different from the audioprocessor one.

For example 11 bands are implemented by use of 2 TDA7317 plus an audioprocessor (TDA731X family).

In case one filtering cell is not needed, a short circuit must be provided between the P1xy and P2xy pins.

## I<sup>2</sup>C BUS INTERFACE

Data transmission from microprocessor to the TDA7317 and viceversa takes place thru the 2 wires I<sup>2</sup>C BUS interface, consisting of the two lines SDA and SCL (pull-up resistors to positive supply voltage must be externally connected).

### Data Validity

As shown in fig. 3, the data on the SDA line must be stable during the high period of the clock. The HIGH and LOW state of the data line can only change when the clock signal on the SCL line is LOW.

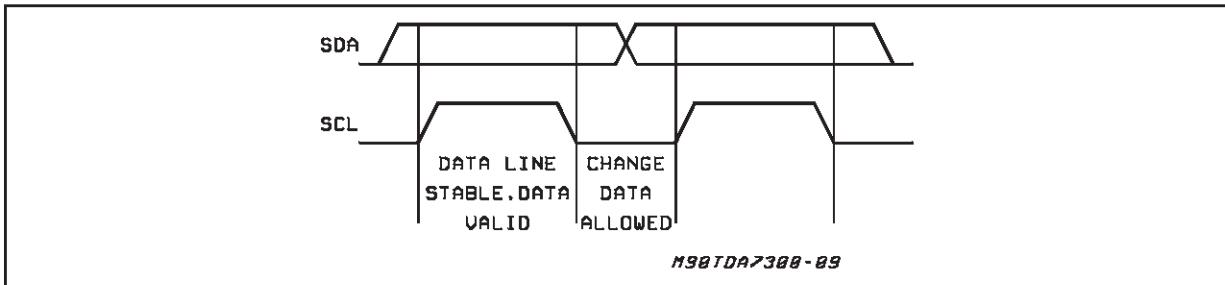
### Start and Stop Conditions

As shown in fig.4 a start condition is a HIGH to LOW transition of the SDA line while SCL is HIGH. The stop condition is a LOW to HIGH transition of the SDA line while SCL is HIGH.

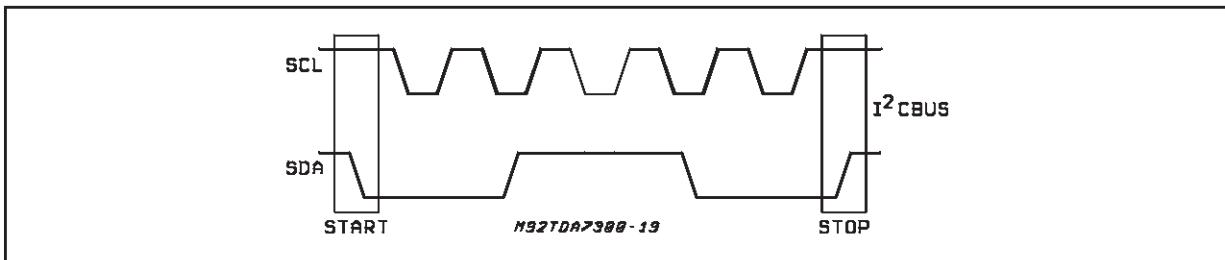
### Byte Format

Every byte transferred to the SDA line must contain 8 bits. Each byte must be followed by an acknowledge bit. The MSB is transferred first.

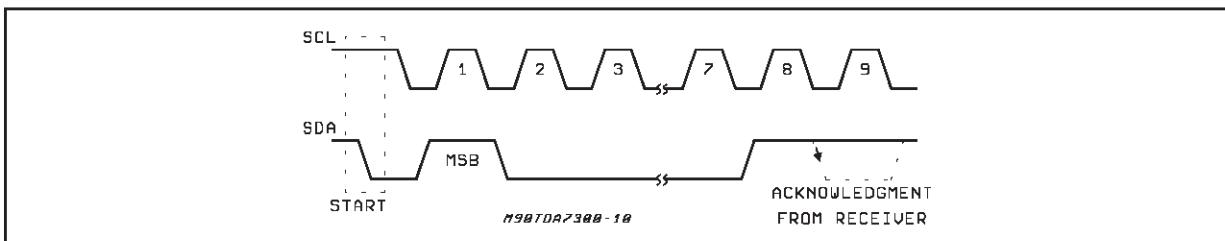
**Figure 3:** Data Validity on the I<sup>2</sup>CBUS



**Figure 4:** Timing Diagram of I<sup>2</sup>CBUS



**Figure 5:** Acknowledge on the I<sup>2</sup>CBUS



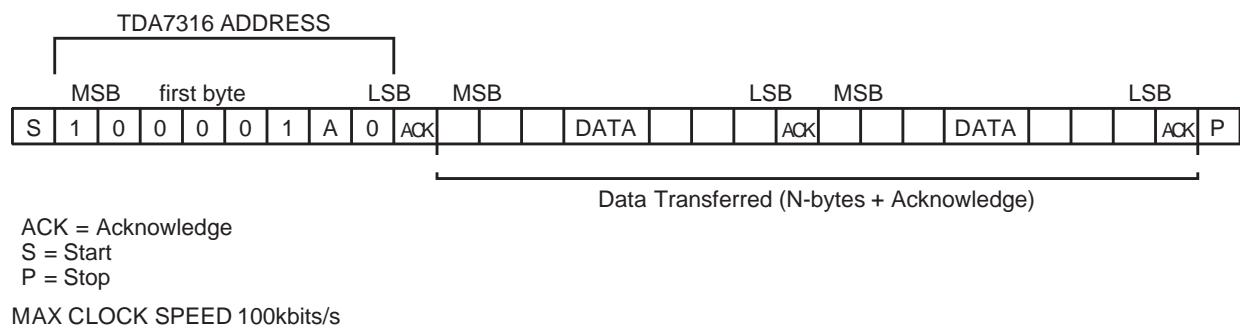
**SOFTWARE SPECIFICATION****Interface Protocol**

The interface protocol comprises:

- A start condition (s)
- A chip address byte, containing the TDA7317

address (the 8th bit of the byte must be 0). The TDA7317 must always acknowledge at the end of each transmitted byte.

- A sequence of data (N-bytes + acknowledge)
- A stop condition (P)

**SOFTWARE SPECIFICATION**

Chip address (84 or 86 Hex)

1	0	0	0	0	1	A	0
MSB						LSB	

A = Logic level on pin ADDR

A = 1 if ADDR pin = open

A = 0 if ADDR pin = connected to ground

**SOFTWARE SPECIFICATION (continued)**

DATA BYTES (detailed description)

**Volume**

MSB						LSB	FUNCTION		
0	X	B2	B1	B0	A2	A1	A0	Volume 0.375dB steps	
					0	0	0	0	
					0	0	1	-0.375	
					0	1	0	-0.75	
					0	1	1	-1.125	
					1	0	0	-1.5	
					1	0	1	-1.875	
					1	1	0	-2.25	
					1	1	1	-2.625	
0						A2	A1	A0	Volume -3dB steps
						0	0	0	0
						0	0	1	-3
						0	1	0	-6
						0	1	1	-9
						1	0	0	-12
						1	0	1	-15

**Graphic Equalizer**

MSB								LSB	FUNCTION
1	D3	D2	D1	D0	S2	C1	C0		
	0	0	0						Band 1
	0	0	1						Band 2
	0	1	0						Band 3
	0	1	1						Band 4
	1	0	0						Band 5
	D3	D2	D1	1	C2	C1	C0		cut
	D3	D2	D1	0	C2	C1	C0		Boost
					0	0	0		0dB
					0	0	1		2dB
					0	1	0		4dB
					0	1	1		6dB
					1	0	0		8dB
					1	0	1		10dB
					1	1	0		12dB
					1	1	1		14dB

AX = 0.375dB steps, BX = 3dB steps, CX = 2dB steps, X = dont'care

STATUS AFTER POWER-ON RESET	
Volume	-17.25dB
Graphic equalizer bands	-12dB

**APPLICATION INFORMATION**

A typical application is indicated in figure 4, while

the P.C. Board and components layout are reported in figure 5. The external components, are calculated for 2 different max boost/cut conditions

**TABLE 1:** Max Boost/cut = 20 dB (each cell =  $\pm 14$ dB)

	F (HZ)	Q	R1 (K $\Omega$ )	R2 (K $\Omega$ )	C1 (nF)	C2 (nF)	Av max (dB)
<b>BAND 1</b>	10363.38	1.49	47	5.1	0.820	1.2	13.52
<b>BAND 2</b>	261.03	1.49	47	5.1	33	47	13.63
<b>BAND 3</b>	1036.34	1.49	47	5.1	8.2	12	13.52
<b>BAND 4</b>	3168.08	1.49	47	5.1	2.7	3.9	13.57
<b>BAND 5</b>	59.75	1.11	43	7.5	220	100	13.88

For THD performance the sequence Band 1, 2, 3, 4, 5, is recommended

**TABLE2:** Max Boost/cut = 17dB (each cell =  $\pm 12$ dB)

	F (HZ)	Q	R1 (K $\Omega$ )	R2 (K $\Omega$ )	C1 (nF)	C2 (nF)	Av max (dB)
<b>BAND 1</b>	10158.00	1.15	33	6.2	1.2	1	11.83
<b>BAND 2</b>	250.81	1.21	30	5.1	47	56	11.33
<b>BAND 3</b>	977.34	1.20	39	6.8	10	10	11.75
<b>BAND 4</b>	3429.00	1.25	39	6.2	2.7	3.3	11.67
<b>BAND 5</b>	61.82	1.15	33	6.2	180	180	11.27

Figure 4

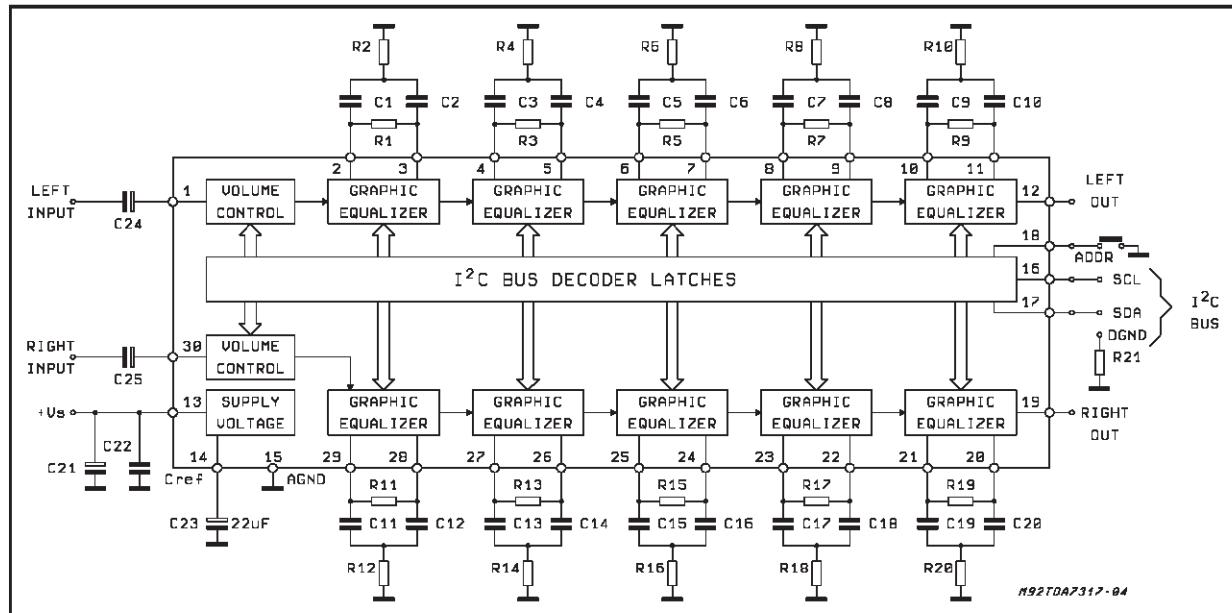
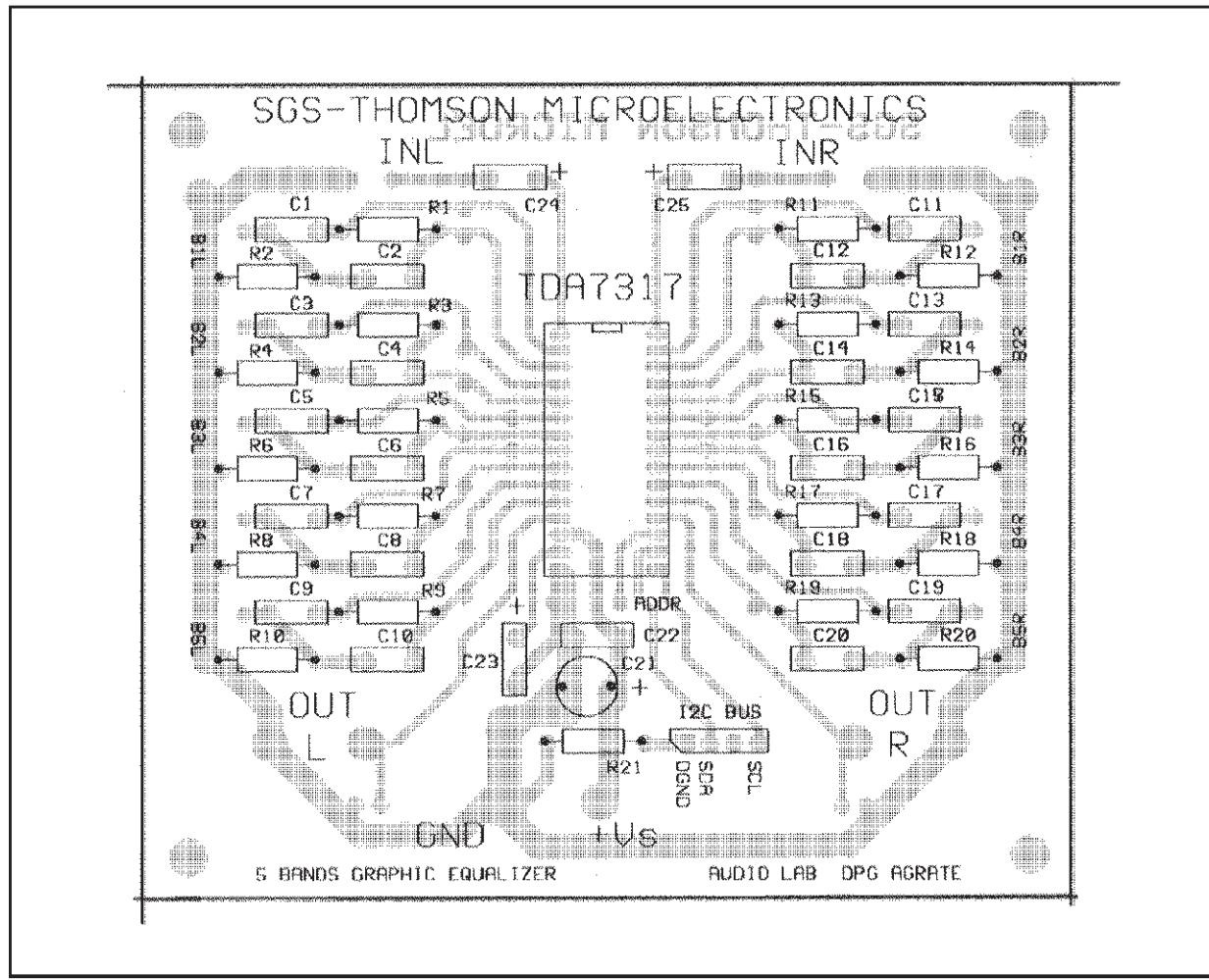


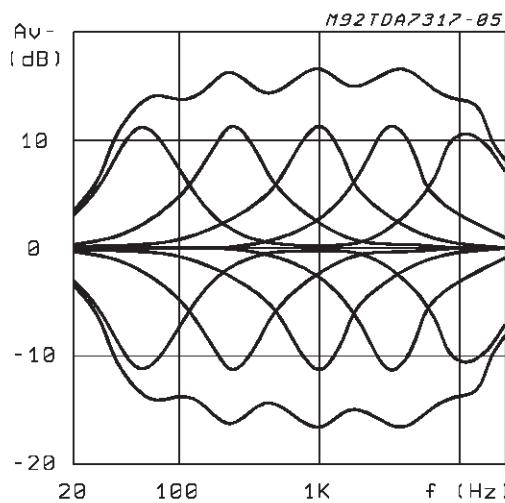
Figure 5: PCP Board and components layout of the figure 4 (scale 1:1)



## TDA7317

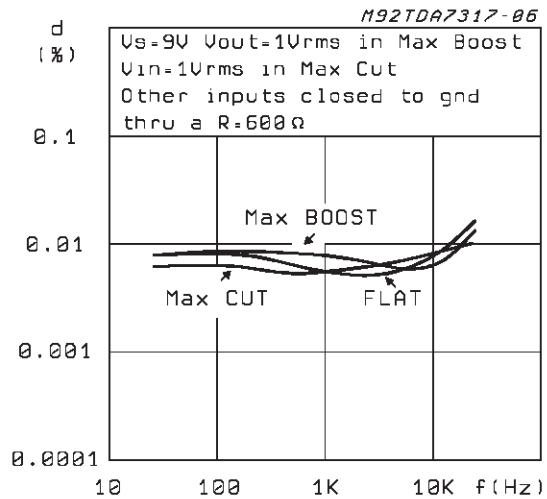
Measurements done on the test jig of fig. 5 using the components indicated in table2, are reported

**Figure 6:** Frequency Response

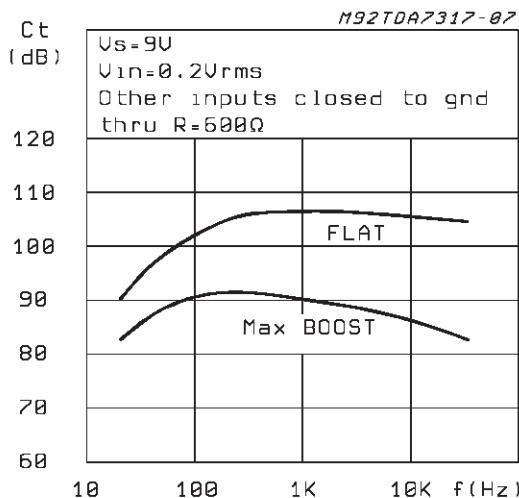


in figg. 6, 7,8.

**Figure 7** THD vs Frequency Max Boost/cut=  $\pm 14\text{dB}$



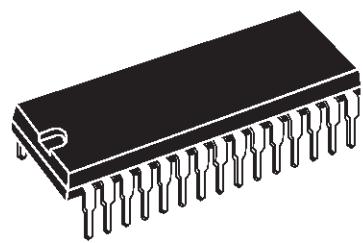
**Figure 8:** Cross Talk vs Frequency



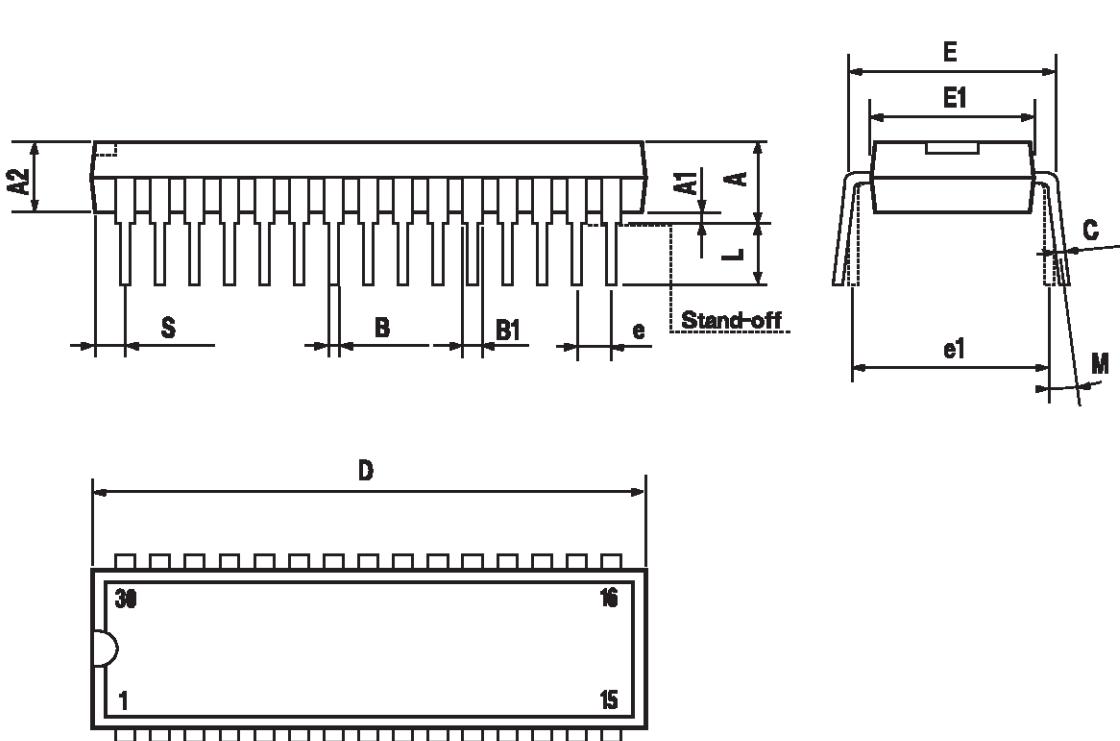
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DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			5.08			0.20
A1	0.51			0.020		
A2	3.05	3.81	4.57	0.12	0.15	0.18
B	0.36	0.46	0.56	0.014	0.018	0.022
B1	0.76	0.99	1.40	0.030	0.039	0.055
C	0.20	0.25	0.36	0.008	0.01	0.014
D	27.43	27.94	28.45	1.08	1.10	1.12
E	10.16	10.41	11.05	0.400	0.410	0.435
E1	8.38	8.64	9.40	0.330	0.340	0.370
e		1.778			0.070	
e1		10.16			0.400	
L	2.54	3.30	3.81	0.10	0.13	0.15
M	0°(min.), 15°(max.)					
S	0.31			0.012		

## OUTLINE AND MECHANICAL DATA



**SDIP30 (0.400")**



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